

Application No.: 10/034,030

Docket No.: JCLA8482

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of :

HORNG ET AL.

Examiner : TRINH, MINH N

Serial No. : 10/034,030

Art Unit : 3729

Filed : 12/19/2001

Docket No. : JCLA8482

For : METHOD OF FABRICATING
A CERAMIC SUBSTRATE WITH
A THERMAL CONDUCTIVE PLUG)
OF A MULTI-CHIP PACKAGE)

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No. JCLA8482).

AMENDMENT AFTER FINAL

Mail Stop AF
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

The Office Action mailed 04/02/2004 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.